Product data sheet

1. General description

Planar passivated Silicon Controlled Rectifier with sensitive gate in a TO92 plastic package. This SCR is designed to be interfaced directly to microcontrollers, logic ICs and other low power gate trigger circuits.

2. Features and benefits

- · Enhanced voltage capability
- · Planar passivated for voltage ruggedness and reliability
- Sensitive gate
- Direct triggering from low power drivers and logic ICs
- A-G-K reverse pin-out

3. Applications

· General purpose switching and phase control

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Absolute	maximum rating					
V_{RRM}	repetitive peak reverse voltage		-	-	600	V
I _{T(AV)}	average on-state current	half sine wave; T _{lead} ≤ 83 °C; <u>Fig. 1</u>	-	-	0.5	А
I _{T(RMS)}	RMS on-state current	half sine wave; T _{lead} ≤ 83 °C; <u>Fig. 2;</u> <u>Fig. 3</u>	-	-	0.8	А
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5	-	-	8	А
		half sine wave; $T_{j(init)} = 25 ^{\circ}C$; $t_p = 8.3 ms$	-	-	9	А
T _j	junction temperature		-	-	125	°C
Static ch	aracteristics					
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 10 \text{ mA}; T_j = 25 ^{\circ}\text{C}; Fig. 7$	-	50	200	μΑ
Dynamic	characteristics					
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 402 V; T_j = 125 °C; R_{GK} = 1 k Ω ; (V_{DM} = 67% of V_{DRM}); exponential waveform; Fig. 12	500	800	-	V/µs
		V_{DM} = 402 V; T_j = 125 °C; (V_{DM} = 67% of V_{DRM}); exponential waveform; gate open circuit; Fig. 12	-	25	-	V/µs

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5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		. 1
2	G	gate		A
3	A	anode	TO-92 (SOT54)	G sym037

6. Ordering information

Table 3. Ordering information

Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
BT149G	TO92	BT149G,412	Bulk	1000	SOT54	14-Nov-2013
BT149G	TO92	BT149G,126	Reel	2000	SOT54 wide pitch	14-Nov-2013

7. Marking

Table 4. Marking codes

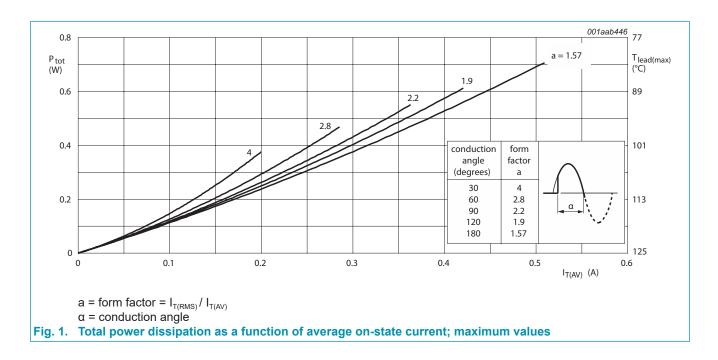
Type number	Marking codes
BT149G	BT149G

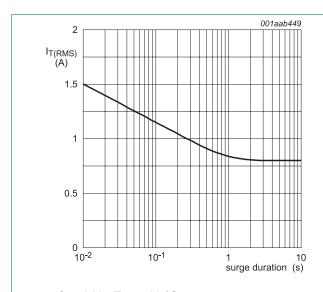
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DRM}	repetitive peak off-state voltage		-	600	V
V_{RRM}	repetitive peak reverse voltage		-	600	V
$I_{T(AV)}$	average on-state current	half sine wave; T _{lead} ≤ 83 °C; <u>Fig. 1</u>	-	0.5	А
I _{T(RMS)}	RMS on-state current	half sine wave; T _{lead} ≤ 83 °C; <u>Fig. 2</u> ; <u>Fig. 3</u>	-	0.8	А
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5	-	8	A
		half sine wave; $T_{j(init)} = 25$ °C; $t_p = 8.3$ ms	-	9	Α
l ² t	I ² t for fusing	t _p = 10 ms; SIN	-	0.32	A ² s
dl _⊤ /dt	rate of rise of on-state current	$I_T = 2 \text{ A}$; $I_G = 10 \text{ mA}$; $dI_G/dt = 100 \text{ mA/}\mu\text{s}$	-	50	A/µs
I _{GM}	peak gate current		-	1	Α
V_{RGM}	peak reverse gate voltage		-	5	V
P_GM	peak gate power		-	2	W
$P_{G(AV)}$	average gate power	over any 20 ms period	-	0.1	W
T _{stg}	storage temperature		-40	150	°C
T _j	junction temperature		-	125	°C





 $f = 50 \text{ Hz}; T_{lead} = 83 \text{ °C}$ Fig. 2. RMS on-state current as a function of surge duration for sinusoidal currents

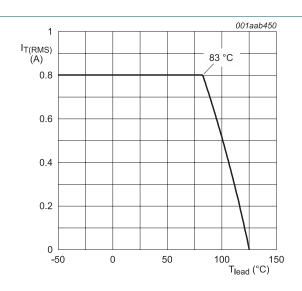


Fig. 3. RMS on-state current as a function of lead temperature; maximum values

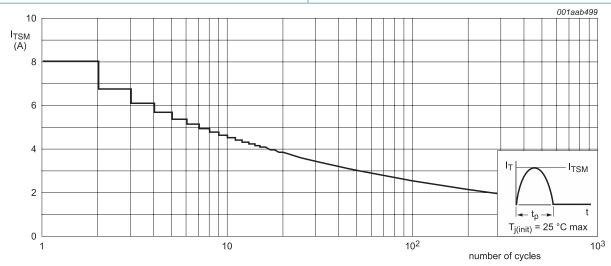
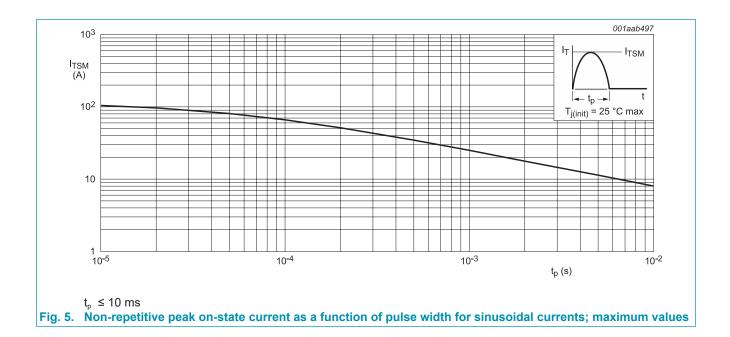


Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal currents cycles; maximum values

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9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-lead)}}$	thermal resistance from junction to lead	Fig. 6	-	-	60	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	printed circuit board mounted: lead length = 4 mm	-	150	-	K/W

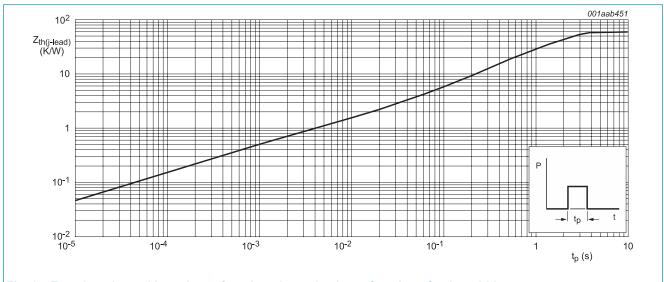


Fig. 6. Transient thermal impedance from junction to lead as a function of pulse width

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10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static ch	aracteristics					
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 10 \text{ mA}; T_j = 25 \text{ °C};$ Fig. 7	-	50	200	μA
I _L	latching current	$V_D = 12 \text{ V}; I_G = 0.5 \text{ mA}; T_j = 25 \text{ °C};$ $R_{GK(ext)} = 1 \text{ k}\Omega; Fig. 8$	-	2	6	mA
I _H	holding current	$V_D = 12 \text{ V}; T_j = 25 \text{ °C}; R_{GK(ext)} = 1 \text{ k}\Omega;$ Fig. 9	-	2	5	mA
V _T	on-state voltage	I _T = 1.2 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.25	1.7	V
V_{GT}	gate trigger voltage	$V_D = 12 \text{ V; } I_T = 10 \text{ mA; } T_j = 25 \text{ °C;}$ Fig. 11	-	0.5	0.8	V
		$V_D = 600 \text{ V}; I_T = 10 \text{ mA}; T_j = 125 \text{ °C}$	0.2	0.3	-	V
I _D	off-state current	$V_D = 600 \text{ V}; R_{GK(ext)} = 1 \text{ k}\Omega; T_j = 125 \text{ °C}$	-	0.05	0.1	mA
I _R	reverse current	$V_R = 600 \text{ V}; T_j = 125 \text{ °C}; R_{GK(ext)} = 1 \text{ k}\Omega$	-	0.05	0.1	mA
Dynamic	characteristics					
D.	rate of rise of off-state voltage	V_{DM} = 402 V; T_j = 125 °C; R_{GK} = 1 kΩ; (V_{DM} = 67% of V_{DRM}); exponential waveform; Fig. 12	500	800	-	V/µs
		V_{DM} = 402 V; T_j = 125 °C; $(V_{DM}$ = 67% of V_{DRM}); exponential waveform; gate open circuit; Fig. 12	-	25	-	V/µs
t _{gt}	gate-controlled turn-on time	$I_{TM} = 2 \text{ A}; V_D = 600 \text{ V}; I_G = 10 \text{ mA}; dI_G/dt = 0.1 \text{ A/µs}; T_j = 25 °C$	-	2	-	μs
t _q	commutated turn-off time	$V_{DM} = 402 \text{ V; } T_{J} = 125 \text{ °C; } I_{TM} = 1.6 \text{ A; } V_{R} = 35 \text{ V; } (dI_{T}/dt)_{M} = 30 \text{ A/}\mu\text{s; } dV_{D}/dt = 2 \text{ V/}\mu\text{s; } R_{GK(ext)} = 1 \text{ k}\Omega\text{; } (V_{DM} = 67\% \text{ of } V_{DRM})$	-	100	-	μs

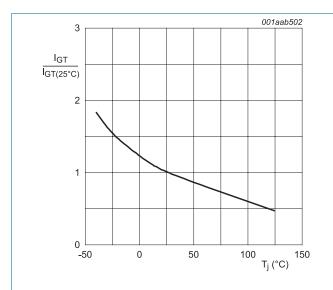
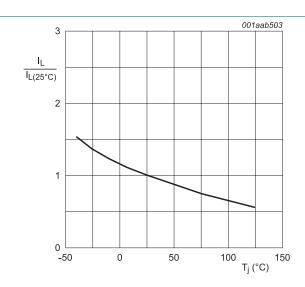
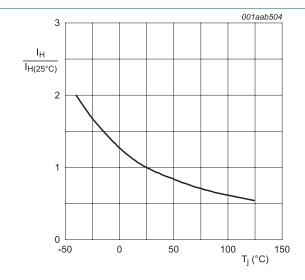


Fig. 7. Normalized gate trigger current as a function of junction temperature

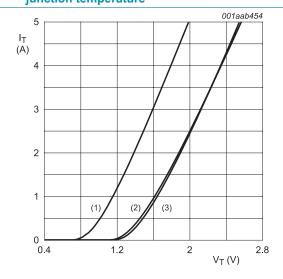


R_{GK} = 1 kΩ

Fig. 8. Normalized latching current as a function of junction temperature



 $R_{\text{GK}} = 1 \text{ k}\Omega$ Fig. 9. Normalized holding current as a function of junction temperature



 V_o = 1.067 V; R_s = 0.187 Ω (1) T_j = 125 °C; typical values (2) T_j = 125 °C; maximum values (3) T_i = 25 °C; maximum values

Fig. 10. On-state current as a function of on-state voltage

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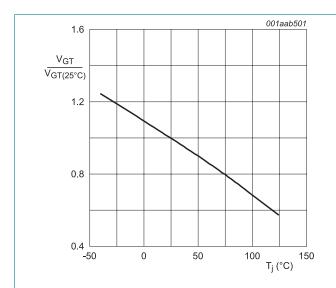
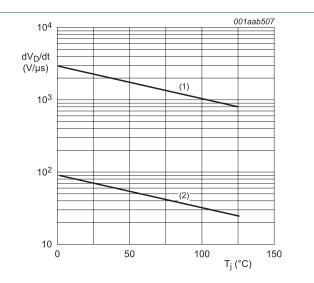
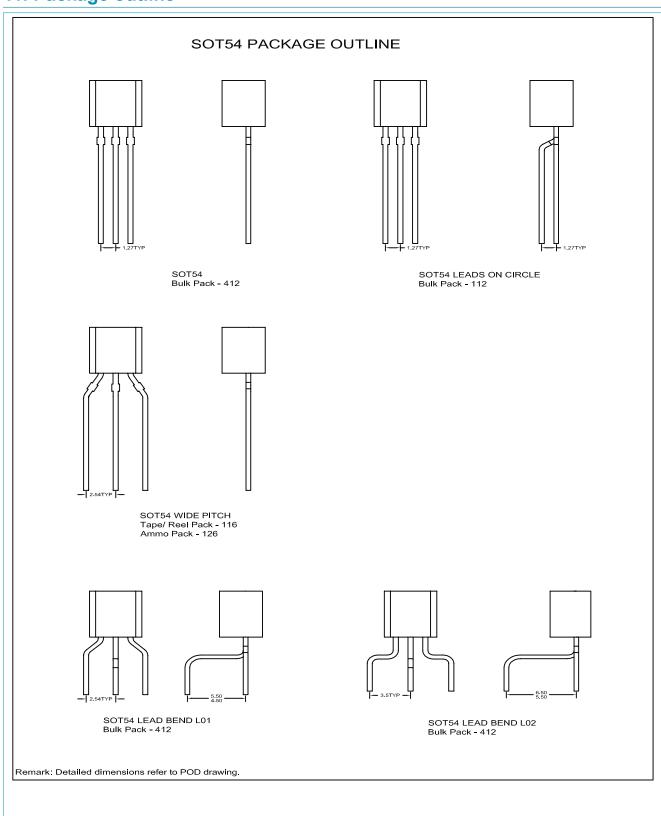


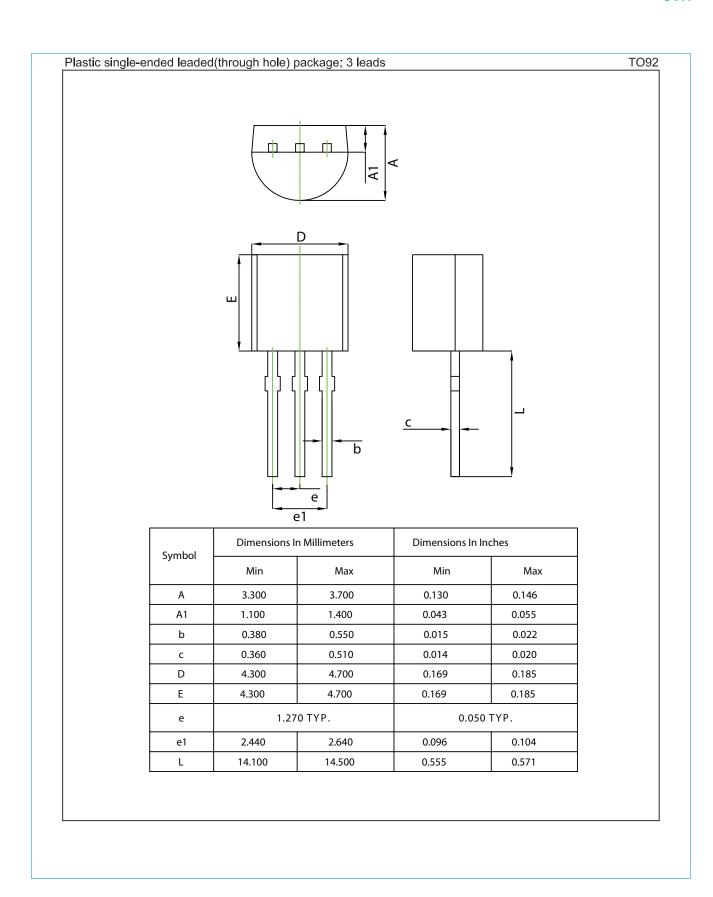
Fig. 11. Normalized gate trigger voltage as a function of junction temperature



(1) R_{GK} = 1 kΩ;
(2) gate open circuit
Fig. 12. Critical rate of rise of off-state voltage as a function of junction temperature; typical values

11. Package outline





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12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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